

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TOMONARI OOTA	02/14/2023
MASAHIDE TAGUCHI	02/14/2023
YUSUKE NAKAYAMA	02/14/2023
HIRONAO NAKAMURA	02/15/2023
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	NUVOTON TECHNOLOGY CORPORATION JAPAN
<b>Street Address:</b>	1 KOTARI-YAKEMACHI, NAGAOKAKYO CITY
<b>City:</b>	KYOTO
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	617-8520
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	18175196
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)756-8087
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	202-756-8000
<b>Email:</b>	ipdocketmwe@mwe.com, broberts@mwe.com
<b>Correspondent Name:</b>	MCDERMOTT WILL & EMERY LLP
<b>Address Line 1:</b>	500 NORTH CAPITOL STREET N.W.
<b>Address Line 4:</b>	WASHINGTON, D.C. 20001
<b>ATTORNEY DOCKET NUMBER:</b>	112655-0251
<b>NAME OF SUBMITTER:</b>	BRIAN ROBERTS
<b>SIGNATURE:</b>	/BRIAN ROBERTS/
<b>DATE SIGNED:</b>	02/27/2023
<b>Total Attachments: 2</b>	
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source=Assignment_112655-0251#page2.tif	

**ASSIGNMENT**

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>Tomonari OOTA</u>	(3) <u>Yusuke NAKAYAMA</u>
(2) <u>Masahide TAGUCHI</u>	(4) <u>Hironao NAKAMURA</u>

who have made a certain new and useful invention, hereby sell, assign and transfer unto

Name: Nuvoton Technology Corporation Japan

Address: 1 Kotari-yakemachi, Nagaokakyo City, Kyoto 617-8520, Japan

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

**SEMICONDUCTOR DEVICE**

- (a) for which an application for United States Letters Patent was filed on \_\_\_\_\_,  
and identified by United States Serial No. \_\_\_\_\_; or
- (b) for which an application for United States Letters Patent was executed on even date,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

Docket No.: \_\_\_\_\_

SIGNED on the dates indicated aside our signatures:

INVENTORS	DATE SIGNED
1) <u>Tomonari Oota</u> Name: Tomonari OOTA	<u>Feb. 14, 2023</u>
2) <u>Masahide Taguchi</u> Name: Masahide TAGUCHI	<u>Feb. 14, 2023</u>
3) <u>Yusuke Nakayama</u> Name: Yusuke NAKAYAMA	<u>Feb. 14, 2023</u>
4) <u>Hironao Nakamura</u> Name: Hironao NAKAMURA	<u>Feb. 15, 2023</u>